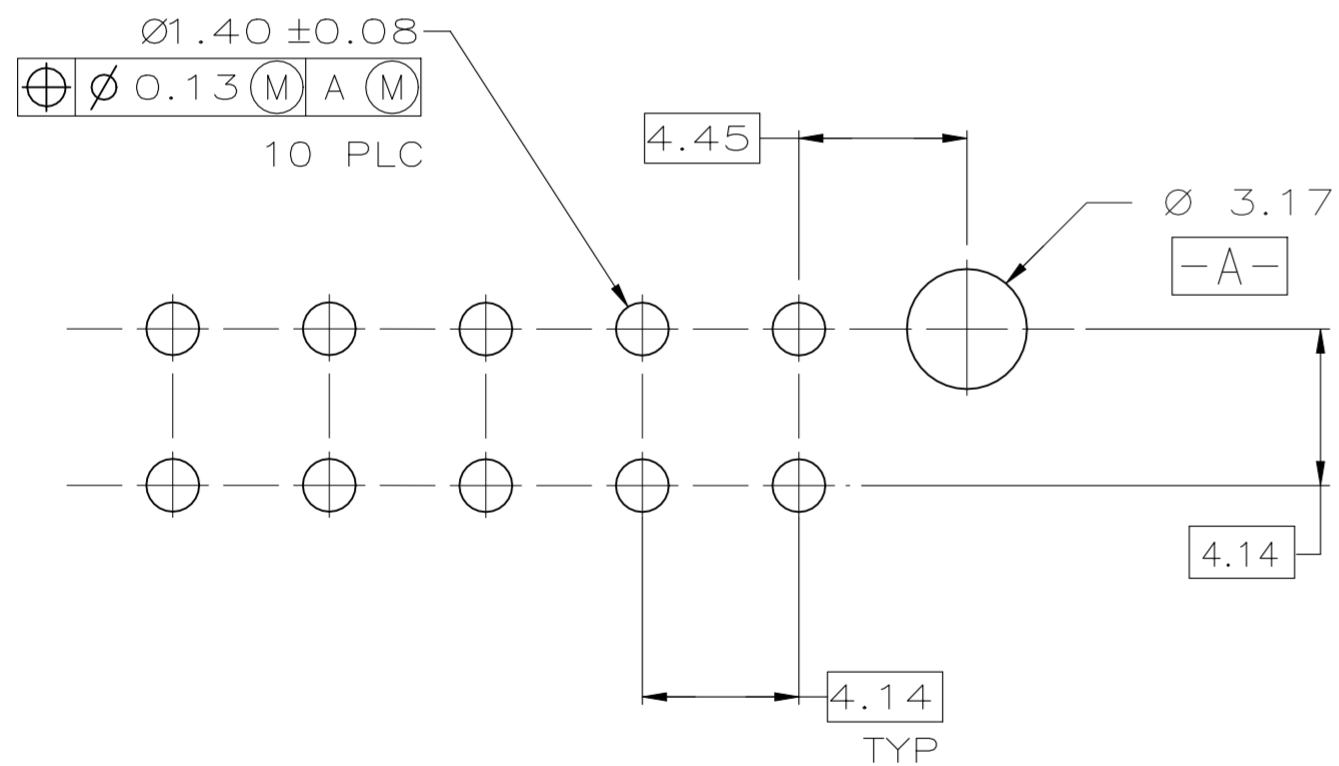
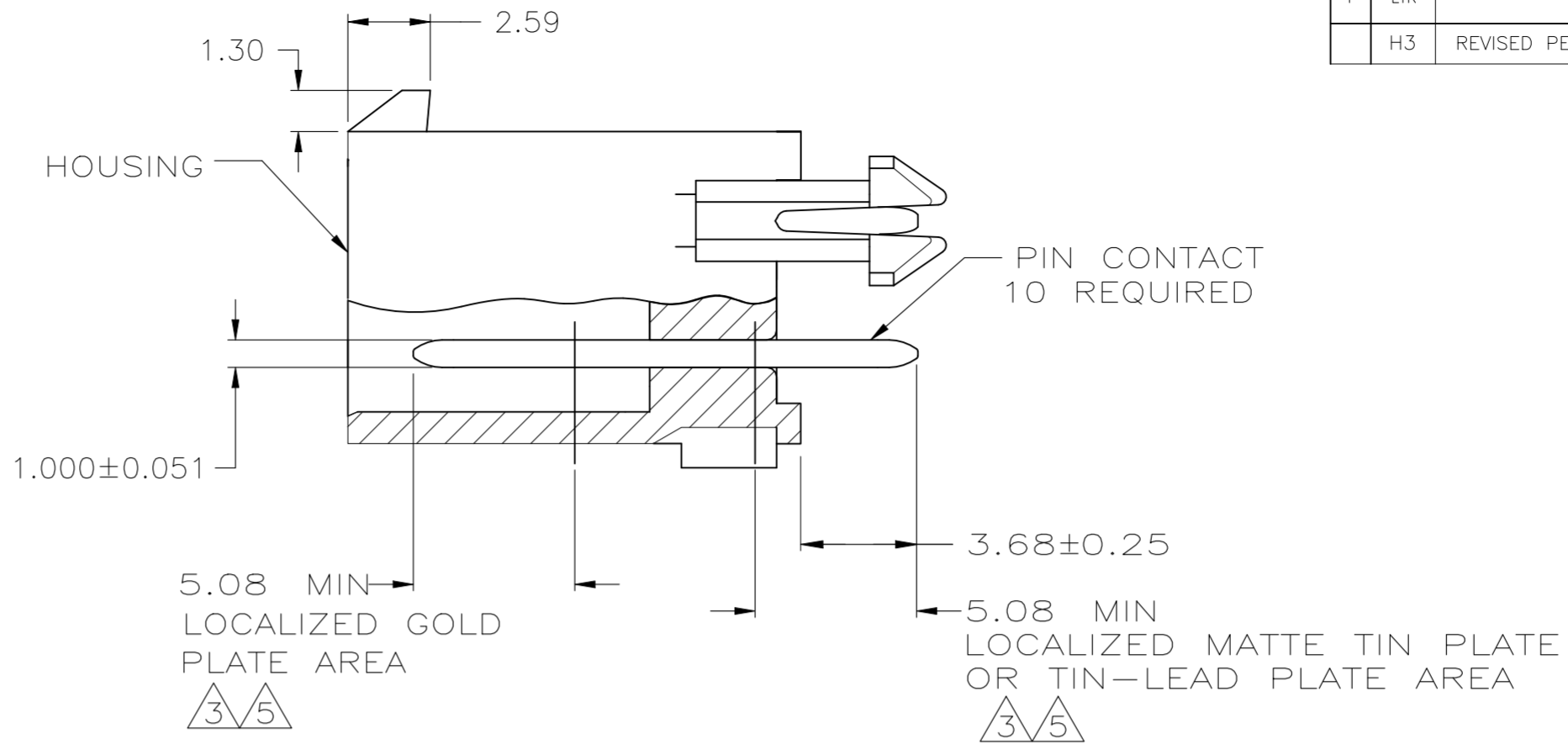
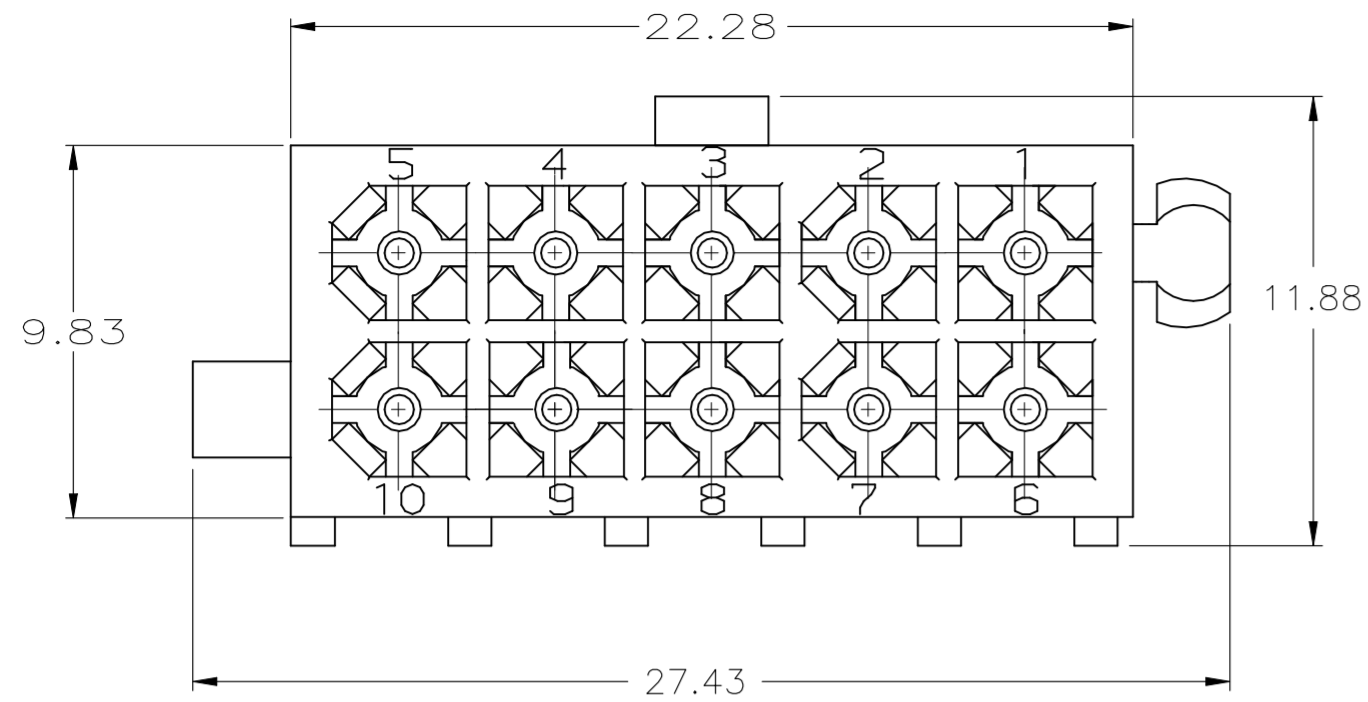
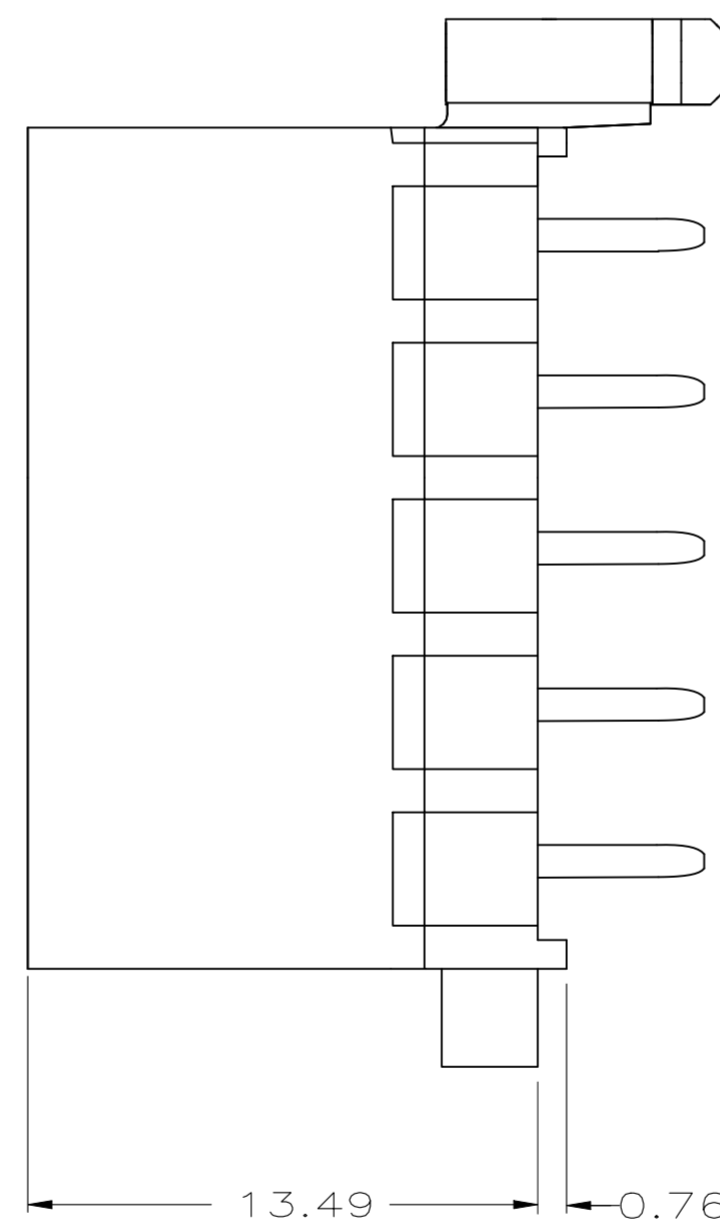


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REVISIONS					
P	LTR	DESCRIPTION	DATE	DWN	APVD
H3		REVISED PER ECR-21-108531	29JUL2021	JP	VS



RECOMMENDED HOLE PATTERN FOR 1.57 THICK BOARD



- PINS TO COMPLY WITH AMP SOLDERABILITY SPEC. 109-11-3.
- 0.00381 MIN MATTE TIN LEAD PLATE OVER 0.00127 MIN NICKEL.
- 0.00076 MIN GOLD PLATE IN THE LOCALIZED PLATE AREA, 0.00381 MATTE TIN LEAD IN THE LOCALIZED PLATE AREA, BOTH OVER 0.00127 MIN NICKEL.
- 0.00381 MIN MATTE TIN PLATE OVER 0.00127 MIN NICKEL.
- 0.00076 MIN GOLD PLATE IN THE LOCALIZED PLATE AREA, 0.00381 MATTE TIN IN THE LOCALIZED PLATE AREA, BOTH OVER 0.00127 MIN NICKEL.

BRASS, GOLD	5	NYLON, UL94V-0	WHITE	1-770743-1
BRASS, TIN	4	NYLON, UL94V-0	WHITE	1-770743-0
OBSOLETE BRASS, GOLD	3	NYLON, UL94V-0	WHITE	-770743-2
BRASS, TIN-LEAD	2	NYLON, UL94V-0	WHITE	770743-1
MATERIAL	FINISH	MATERIAL	COLOR	PART NO.
PIN		HOUSING		

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN S CARPENTER 08JUN05	TE Connectivity	
DIMENSIONS: mm		CHK R JONES 29JUL2003	NAME HEADER ASSEMBLY, 10 CKT, DOUBLE ROW VERTICAL MINI UNIVERSAL MATE-N-LOK	
TOLERANCES UNLESS OTHERWISE SPECIFIED: 0 PLC ± - 1 PLC ± - 2 PLC ± 0.13 3 PLC ± - 4 PLC ± - ANGLES ± -		APVD R JONES 29JUL2003	DRAWING NO A2 00779 C=770743	
MATERIAL		PRODUCT SPEC	SCALE 5:1	SHEET 1 of 1
FINISH		APPLICATION SPEC	RESTRICTED TO	REV H3
MATERIAL		WEIGHT	CUSTOMER DRAWING	